SCES551C-FEBRUARY 2004-REVISED AUGUST 2005

FEATURES

- Control Inputs V_{IH}/V_{IL} Levels Are Referenced to V_{CCA} Voltage
- V_{CC} Isolation Feature If Either V_{CC} Input Is at GND, Both Ports Are in the High-Impedance State
- Overvoltage-Tolerant Inputs/Outputs Allow Mixed-Voltage-Mode Data Communications
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.2-V to 3.6-V Power-Supply Range
- I_{off} Supports Partial-Power-Down Mode Operation
- I/Os Are 4.6-V Tolerant
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 8000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

DESCRIPTION/ORDERING INFORMATION

This 16-bit noninverting bus transceiver uses two separate configurable power-supply rails. The SN74AVC16T245 is optimized to operate with $V_{\rm CCA}/V_{\rm CCB}$ set at 1.4 V to 3.6 V. It is operational with $V_{\rm CCA}/V_{\rm CCB}$ as low as 1.2 V. The A port is designed to track $V_{\rm CCA}$. $V_{\rm CCA}$ accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track $V_{\rm CCB}$. $V_{\rm CCB}$ accepts any supply voltage from 1.2 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

	,		
1DIR	1	48	10E
1B1 [2	47] 1A1_
1B2 [3	46	1A2
GND [4	45] GND
1B3 [5	44	1A3
1B4 [6	43] 1A4
V _{CCB} [7	42	V _{CCA}
1B5 [8	41	1A5
1B6 [9	40	1A6
GND [10	39] GND
1B7 [11	38	1A7
1B8 [12	37	1A8
2B1 [13	36	2A1
2B2 [14	35	2A2
GND [15	34] GND
2B3	16	33	2A3

2B4 **∏** 17

V_{CCB} [] 18

2B5 19

2B6 ∏ 20

GND **1** 21

2B7 **∏** 22

2B8 🛮 23

2DIR [

DGG OR DGV PACKAGE

(TOP VIEW)

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32 1 2A4

31 V_{CCA}

30 2A5

29 2A6

28 GND

27 2A7

26 2A8

25 20E

The SN74AVC16T245 is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (OE) input can be used to disable the outputs so the buses effectively are isolated.

The SN74AVC16T245 is designed so that the control pins (1DIR, 2DIR, $1\overline{OE}$, and $2\overline{OE}$) are supplied by V_{CCA} .

ORDERING INFORMATION

T _A	PACKAGE	(1)	ORDERABLE PART NUMBER	TOP-SIDE MARKING		
11003.	TSSOP - DGG	Tape and reel	SN74AVC16T245DGGR	AVC16T245		
400C to 050C	TVSOP - DGV	Tape and reel	SN74AVC16T245DGVR	WF245		
–40°C to 85°C	VFBGA – GQL	Tono and week	SN74AVC16T245GQLR	WE045		
	VFBGA – ZQL (Pb-free)	Tape and reel	SN74AVC16T245ZQLR	WF245		

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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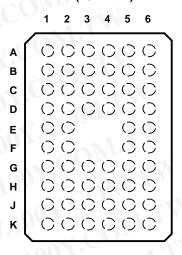
DESCRIPTION/ORDERING INFORMATION (CONTINUED)

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, both ports are in the high-impedance state.

To ensure the high-impedance state during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

GQL OR ZQL PACKAGE (TOP VIEW)



TERMINAL ASSIGNMENTS(2)

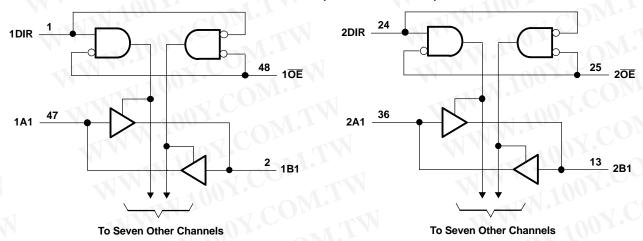
	1	2	3	4	5	6
A	1DIR	NC	NC	NC	NC	1 OE
В	1B2	1B1	GND	GND	1A1	1A2
C	1B4	1B3	V _{CCB}	V _{CCA}	1A3	1A4
D	1B6	1B5	GND	GND	1A5	1A6
T (E)	1B8	1B7		CUP	1A7	1A8
F	2B1	2B2		7.0	2A2	2A1
G	2B3	2B4	GND	GND	2A4	2A3
Н	2B5	2B6	V _{CCB}	V _{CCA}	2A6	2A5
J	2B7	2B8	GND	GND	2A8	2A7
K	2DIR	NC	NC	NC	NC	2 OE

(2) NC - No internal connection

FUNCTION TABLE (EACH 8-BIT SECTION)

INP	UTS	OPERATION
OE	DIR	OPERATION
L	L	B data to A bus
L	Н	A data to B bus
Н	X	Isolation

LOGIC DIAGRAM (POSITIVE LOGIC)



Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

1.7	CON	1.	MIN	MAX	UNIT
V_{CCA}	Supply voltage range		-0.5	4.6	V
Mr.	TIN WOOD TO CO	I/O ports (A port)	-0.5	4.6	- 0
VI	Input voltage range (2)	I/O ports (B port)	-0.5	4.6	V
		Control inputs	-0.5	4.6	
V	Voltage range applied to any output	A port	-0.5	4.6	sī û
Vo	in the high-impedance or power-off state (2)	B port	-0.5	4.6	V
V	Valtage range applied to any output in the high or law state (2)(3)	A port	-0.5	$V_{CCA} + 0.5$	V
Vo	Voltage range applied to any output in the high or low state ⁽²⁾⁽³⁾	B port	-0.5	V _{CCB} + 0.5	V
I _{IK}	Input clamp current	V _I < 0		-50	mA
lok	Output clamp current	V _O < 0		-50	mA
l ₀	Continuous output current			±50	mA
	Continuous current through each V _{CCA} , V _{CCB} , and GND	COM-		±100	mA
~ 7 (CO	DGG package		70	
θ_{JA}	Package thermal impedance (4)	DGV package		58	°C/W
	COM	GQL/ZQL package	QL package		
T _{stg}	Storage temperature range	10.	-65	150	°C

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The package thermal impedance is calculated in accordance with JESD 51-7.

The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed. The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.



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Recommended Operating Conditions (1)(2)(3)

			V _{CCI}	V _{cco}	MIN	MAX	UNIT
V _{CCA}	Supply voltage	-1 COM.	- 1		1.2	3.6	V
V _{CCB}	Supply voltage				1.2	3.6	V
		COM	1.2 V to 1.95 V	-755	$V_{CCI} \times 0.65$	-7 CO	
V _{IH}	High-level input voltage	Data inputs ⁽⁴⁾	1.95 V to 2.7 V		1.6	1. To	V
	input voltage	Jun 2011	2.7 V to 3.6 V		2		
			1.2 V to 1.95 V			$V_{CCI} \times 0.35$	
V_{IL}	Low-level input voltage	Data inputs ⁽⁴⁾	1.95 V to 2.7 V		-4111	0.7	V
	input voltage		2.7 V to 3.6 V			0.8	
		11100	1.2 V to 1.95 V		$V_{CCA} \times 0.65$	100	~O
V_{IH}	High-level input voltage	DIR (referenced to V _{CCA}) ⁽⁵⁾	1.95 V to 2.7 V	4	1.6		V
	input voltage	(referenced to ACCV)	2.7 V to 3.6 V		2	100	
-11		1 No.	1.2 V to 1.95 V	I		$V_{CCA} \times 0.35$	
V_{IL}	Low-level input voltage	DIR (referenced to V _{CCA}) ⁽⁵⁾	1.95 V to 2.7 V			0.7	V
	input voitage	(referenced to v _{CCA})(*)	2.7 V to 3.6 V	(M)	-31	0.8	
VI	Input voltage	1007.	- 17		0	3.6	V
.,	10 otrosto otros	Active state	COMP	- 1	0	V _{cco}	~ 1
Vo	Output voltage	3-state			0	3.6	V
1.		3111.10	- COMP.	1.2 V		-3	
			1	1.4 V to 1.6 V		-6	
I _{OH}	High-level output cu	ırrent		1.65 V to 1.95 V		-8	mA
				2.3 V to 2.7 V		-9	
				3 V to 3.6 V		-12	
72				1.2 V	4	3	4 (
			00 -	1.4 V to 1.6 V		6	
l _{OL}	Low-level output current			1.65 V to 1.95 V		8	mA
	W.T.		100 -	2.3 V to 2.7 V		9	
				3 V to 3.6 V	N	12	
Δt/Δν	Input transition rise	or fall rate	1100 }			5	ns/V
T _A	Operating free-air to	emperature	N. 27		-40	85	°C

⁽¹⁾

(2) (3)

 V_{CCI} is the V_{CC} associated with the data input port. V_{CCO} is the V_{CC} associated with the output port. All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004. For V_{CCI} values not specified in the data sheet, V_{IH} min = $V_{CCI} \times 0.7 \text{ V}$, V_{IL} max = $V_{CCI} \times 0.3 \text{ V}$.

For V_{CCA} values not specified in the data sheet, V_{IH} min = $V_{CCA} \times 0.7$ V, V_{IL} max = $V_{CCA} \times 0.3$ V.



Electrical Characteristics (1)(2)

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST COND	ITIONS		- 1 v	$T_A = 25^{\circ}C$		-40°C to 8	UNIT		
PARA	AMETER	TEST COND	IIIONS	V _{CCA}	V _{CCB}	MIN TYP	MAX	MIN	MAX	UNIT	
		$I_{OH} = -100 \mu A$	0	1.2 V to 3.6 V	1.2 V to 3.6 V	-737		V _{CCO} - 0.2	CU	M.	
		$I_{OH} = -3 \text{ mA}$		1.2 V	1.2 V	0.95		1007			
,		$I_{OH} = -6 \text{ mA}$	V	1.4 V	1.4 V			1.05	7 (
∕он		$I_{OH} = -8 \text{ mA}$	$V_I = V_{IH}$	1.65 V	1.65 V			1.2	Y.	V	
		$I_{OH} = -9 \text{ mA}$	100	2.3 V	2.3 V		-11	1.75	- 0		
		$I_{OH} = -12 \text{ mA}$		3 V	3 V			2.3	17.7		
		I _{OL} = 100 μA	x1 1W	1.2 V to 3.6 V	1.2 V to 3.6 V			TAN JU	0.2	<u>~</u>	
		I _{OL} = 3 mA	110	1.2 V	1.2 V	0.15			MY.		
,		$I_{OL} = 6 \text{ mA}$	$V_I = V_{IL}$	1.4 V	1.4 V			-TXV 1	0.35	AZ/	
OL.		I _{OL} = 8 mA	$v_1 = v_1 L$	1.65 V	1.65 V				0.45	7 V	
		I _{OL} = 9 mA	1	2.3 V	2.3 V			-33	0.55		
	κT	I _{OL} = 12 mA		3 V	3 V	K X I			0.7	1	
	Control inputs	V _I = V _{CCA} or GI	ND	1.2 V to 3.6 V	1.2 V to 3.6 V	±0.025 ±0.25			±1	μА	
	A or B port	V V 0	2.2.1	0 V	0 to 3.6 V	±0.1 ±2.5			±5		
off	A or B	V_1 or $V_0 = 0$ to	3.6 V	0 to 3.6 V	0 V	±0.5	±2.5	WW	±5	μΑ	
oz ⁽³⁾	A or B port	$V_O = V_{CCO}$ or O $V_I = V_{CCI}$ or O O E $=$ V_{IH}	SND, ID,	3.6 V	3.6 V	±0.5	±2.5	WV	±5	μА	
	1.0	_7	_ =	1.2 V to 3.6 V	1.2 V to 3.6 V	-31		-11	25	•	
CCA		$V_I = V_{CCI}$ or GN $I_O = 0$	ID,	0 V	3.6 V				-5	μΑ	
		10 – 0		3.6 V	0 V	Mr.	ſ		25		
	- 11			1.2 V to 3.6 V	1.2 V to 3.6 V				25	-7	
ССВ		$V_I = V_{CCI}$ or GN $I_O = 0$	ID,	0 V	3.6 V	OLIV.	_7		25	μΑ	
		10 - 0		3.6 V	0 V			4	-5		
CCA +	· I _{CCB}	$V_I = V_{CCI}$ or GN $I_O = 0$	ID,	1.2 V to 3.6 V	1.2 V to 3.6 V	$CO_{M_{1}}$			45	μА	
Ç _i	Control	V _I = 3.3 V or G	ND	3.3 V	3.3 V	3.5		1		pF	
cio	A or B	V _O = 3.3 V or G	SND	3.3 V	3.3 V	7	IV			pF	

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 V_{CCO} is the V_{CC} associated with the output port. V_{CCI} is the V_{CC} associated with the input port. For I/O ports, the parameter I_{OZ} includes the input leakage current.

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Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 1.2 \text{ V}$ (see Figure 11)

DADAMETED	FROM	то	V _{CCB} = 1.2 V	V _{CCB} = 1.5 V	V _{CCB} = 1.8 V	V _{CCB} = 2.5 V	V _{CCB} = 3.3 V	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	TYP	TYP	TYP	TYP	TYP	CIVIT	
t _{PLH}		D	4.1	3.3	3	2.8	3.2		
t _{PHL}	Α	В	4.1	3.3	3	2.8	3.2	ns	
t _{PLH}	В	100	4.4	4	3.8	3.6	3.5		
t _{PHL}	В	A	4.4	4	3.8	3.6	3.5	ns	
t _{PZH}	ŌĒ	1 A	6.4	6.4	6.4	6.4	6.4		
t _{PZL}	OE	A	6.4	6.4	6.4	6.4	6.4	ns	
t _{PZH}	ŌĒ	B	6	4.6	4	3.4	3.2	$\sim 0^{1}$	
t _{PZL}	OE	В	6	4.6	4	3.4	3.2	ns	
t _{PHZ}	ŌĒ	- A	6.6	6.6	6.6	6.6	6.8		
t _{PLZ}	OE	A	6.6	6.6	6.6	6.6	6.8	ns	
t _{PHZ}	OF.	psi 1	6	4.9	4.9	4.2	5.3		
t _{PLZ}	ŌĒ	В	6	4.9	4.9	4.2	5.3	ns	

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.5 V \pm 0.1 V (see Figure 11)

PARAMETER	FROM (INPUT)	TO	V _{CCB} = 1.2 V	V _{CCB} = ± 0.		V _{CCB} = ± 0.1		V _{CCB} = ± 0.2		V _{CCB} = ± 0.3		UNIT	
Mr	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
t _{PLH}	^	В	3.6	0.5	6.2	0.5	5.2	0.5	4.1	0.5	3.7	100	
t _{PHL}	Α	В	3.6	0.5	6.2	0.5	5.2	0.5	4.1	0.5	3.7	ns	
t _{PLH}	В	Α	3.3	0.5	6.2	0.5	5.9	0.5	5.6	0.5	5.5	1 A	
t _{PHL}	В	A	3.3	0.5	6.2	0.5	5.9	0.5	5.6	0.5	5.5	ns	
t _{PZH}	ŌĒ	Α	4.3	1	10.1	1	10.1	1	10.1	1	10.1	200	
t _{PZL}	OE	OE	A	4.3	1	10.1	1	10.1	1	10.1	1	10.1	ns
t _{PZH}	ŌĒ	B	5.6	1	10.1	0.5	8.1	0.5	5.9	0.5	5.2		
t _{PZL}	OE	В	5.6	111	10.1	0.5	8.1	0.5	5.9	0.5	5.2	ns	
t _{PHZ}	ŌĒ	А	4.5	1.5	9.1	1.5	9.1	1.5	9.1	1.5	9.1	no	
t _{PLZ}	OE	A	4.5	1.5	9.1	1.5	9.1	1.5	9.1	1.5	9.1	ns	
t _{PHZ}	ŌĒ	PHZ OE	В	5.5	1.5	8.7	1.5	7.5	1	6.5	1	6.3	200
t _{PLZ}			В	5.5	1.5	8.7	1.5	7.5	1	6.5	1	6.3	ns

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Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.8 V \pm 0.15 V (see Figure 11)

PARAMETER	FROM (INPUT)		TO	V _{CCB} = 1.2 V	V _{CCB} = ± 0.		V _{CCB} = ± 0. 1		V _{CCB} = ± 0.2		V _{CCB} = ± 0.3		UNIT
		(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
t _{PLH}	Α	В	3.4	0.5	5.9	0.5	4.8	0.5	3.7	0.5	3.3		
t _{PHL}	A	100	3.4	0.5	5.9	0.5	4.8	0.5	3.7	0.5	3.3	ns	
t _{PLH}	В	4	3	0.5	5.2	0.5	4.8	0.5	4.5	0.5	4.4	200	
t _{PHL}	Ь	A	3	0.5	5.2	0.5	4.8	0.5	4.5	0.5	4.4	ns	
t _{PZH}	ŌĒ	^	3.4	1	7.8	1	7.8	1	7.8	1	7.8		
t _{PZL}	OE	A 00	3.4	1	7.8	1	7.8	1	7.8	1 1	7.8	ns	
t _{PZH}	ŌĒ	В	5.4	1	9.2	0.5	7.4	0.5	5.3	0.5	4.5	ns	
t _{PZL}	OE	-110	5.4	1	9.2	0.5	7.4	0.5	5.3	0.5	4.5	115	
t _{PHZ}	oe		4.2	1.5	7.7	1.5	7.7	1.5	7.7	1.5	7.7		
t _{PLZ}	OĒ	ŌĒ	Α	4.2	1.5	7.7	1.5	7.7	1.5	7.7	1.5	7.7	ns
t _{PHZ}	OF.	В	5.2	1.5	8.4	1.5	7.1	1	5.9	1	5.7	<1C	
t _{PLZ}	ŌĒ		5.2	1.5	8.4	1.5	7.1	1	5.9	1	5.7	ns	

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 2.5 V \pm 0.2 V (see Figure 11)

PARAMETER	FROM	TO	V _{CCB} = 1.2 V	V _{CCB} = ± 0.	1.5 V 1 V	V _{CCB} = ± 0.1	1.8 V 5 V	V _{CCB} = ± 0.2		V _{CCB} = ± 0.3		UNIT
	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	۸	В	3.2	0.5	5.6	0.5	4.5	0.5	3.3	0.5	2.8	·In
t _{PHL}	A	В	3.2	0.5	5.6	0.5	4.5	0.5	3.3	0.5	2.8	ns
t _{PLH}	В	^	2.6	0.5	4.1	0.5	3.7	0.5	3.3	0.5	3.2	
t _{PHL}	D	A	2.6	0.5	4.1	0.5	3.7	0.5	3.3	0.5	3.2	ns
t _{PZH}	ŌĒ	^	2.5	0.5	5.3	0.5	5.3	0.5	5.3	0.5	5.3	
t _{PZL}	OE	Α	2.5	0.5	5.3	0.5	5.3	0.5	5.3	0.5	5.3	ns
t _{PZH}	ŌĒ	В	5.2	0.5	9.4	0.5	7.3	0.5	5.1	0.5	4.5	
t _{PZL}	UE	В	5.2	0.5	9.4	0.5	7.3	0.5	5.1	0.5	4.5	ns
t _{PHZ}	ŌĒ	А	3	_ 1	6.1	1	6.1	1	6.1	1	6.1	
t _{PLZ}	OE.	A	3	1	6.1	1	6.1	1	6.1	1	6.1	ns
t _{PHZ}	ŌE	В	5	1	7.9	1	6.6	1	6.1	1	5.2	
t _{PLZ}	OE	В	5	1	7.9	1	6.6	1	6.1	1	5.2	ns



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Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 3.3 V \pm 0.3 V (see Figure 11)

PARAMETER	FROM (INPUT)		TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = ± 0.1	1.5 V I V	V _{CCB} = ± 0.1		V _{CCB} = ± 0.2		V _{CCB} = ± 0.3		UNIT
		(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
t _{PLH}		В	3.2	0.5	5.5	0.5	4.4	0.5	3.2	0.5	2.7		
t _{PHL}	Α	100	3.2	0.5	5.5	0.5	4.4	0.5	3.2	0.5	2.7	ns	
t _{PLH}	В	A	2.8	0.5	3.7	0.5	3.3	0.5	2.8	0.5	2.7	200	
t _{PHL}	D	41 1 O U 3	2.8	0.5	3.7	0.5	3.3	0.5	2.8	0.5	2.7	ns	
t _{PZH}	ŌĒ	^	2.2	0.5	4.3	0.5	4.2	0.5	4.1	0.5	4		
t _{PZL}	OE	A 00	2.2	0.5	4.3	0.5	4.2	0.5	4.1	0.5	4	ns	
t _{PZH}	ŌĒ	В	5.1	0.5	9.3	0.5	7.2	0.5	4.9	0.5	4	ns	
t _{PZL}	OE	110	5.1	0.5	9.3	0.5	7.2	0.5	4.9	0.5	4	115	
t _{PHZ}	OE .	A	3.4	0.5	5	0.5	5	0.5	5	0.5	5		
t _{PLZ}	ŌĒ	A	3.4	0.5	5	0.5	5	0.5	5	0.5	5	ns	
t _{PHZ}	ŌĒ B	В	4.9	1	7.7	1	6.5	1	5.2	0.5	5	√Ino	
t _{PLZ}	OE .		4.9	1	7.7	1	6.5	1	5.2	0.5	5	ns	

Operating Characteristics

 $T_{\Delta} = 25^{\circ}C$

M.T	PARAME	TER	TEST CONDITIONS	V _{CCA} = V _{CCB} = 1.2 V	V _{CCA} = V _{CCB} = 1.5 V	V _{CCA} = V _{CCB} = 1.8 V	V _{CCA} = V _{CCB} = 2.5 V	V _{CCA} = V _{CCB} = 3.3 V	UNIT
			CONDITIONS	TYP	TYP	TYP	TYP	TYP	
DIM	A to B	Outputs enabled		1	J CON	1	1	2	.70
C _{pdA} ⁽¹⁾	AIOB	Outputs disabled	$C_L = 0,$ f = 10 MHz,	1	1.0	1	1	1	pF
OpdA	B to A	Outputs enabled	$t_r = t_f = 1 \text{ ns}$	13	13	14	15	16	рг
	B to A	Outputs disabled	W	1	1.	1 1	1	1	
	A to B	Outputs enabled		13	13	14	15	16	
C (1)	A to B	Outputs disabled	$C_L = 0$,	1	1	CO_{1}	1	1	
C _{pdB} ⁽¹⁾	P to A	Outputs enabled	$f = 10 \text{ MHz},$ $t_r = t_f = 1 \text{ ns}$	1	1700,	1)1/1	1	2	pF
You	B to A	Outputs disabled		1	100	1	1	1	

⁽¹⁾ Power dissipation capacitance per transceiver

Table 1. Typical Total Static Power Consumption (I_{CCA} + I_{CCB})

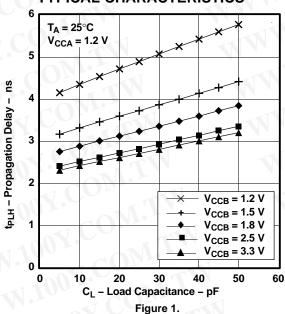
V _{CCB} 0 V 1.2 V 1.5 V 1.8 V 2.5 V 3.3 V 0 V 0 <0.5 <0.5 <0.5 <0.5 <0.5	UNIT
1.2 V <0.5 <1 <1 <1 <1 1	
1.5 V <0.5 <1 <1 <1 <1 1	^
1.8 V <0.5 <1 <1 <1 <1 <1	μΑ
2.5 V <0.5 1 <1 <1 <1 <1 <1	
3.3 V <0.5 1 <1 <1 <1 <1	

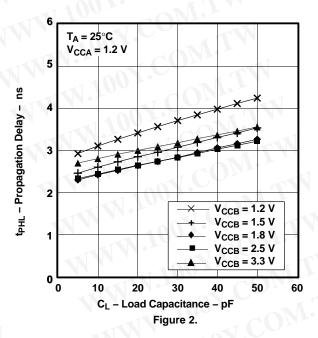
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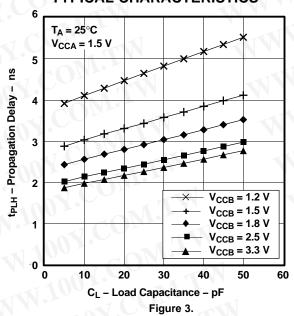
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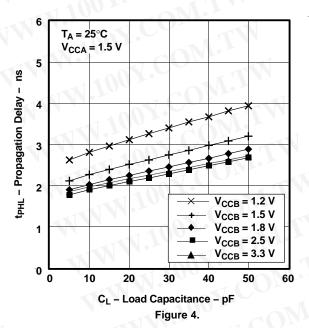
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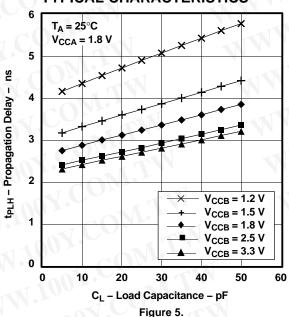


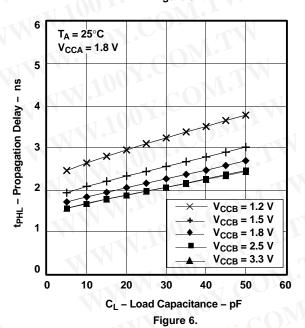


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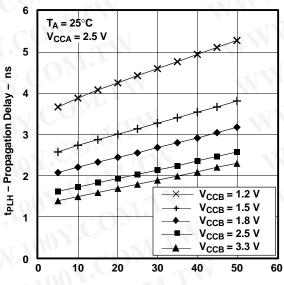




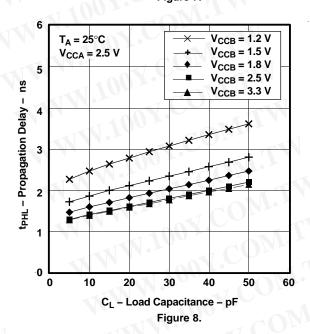




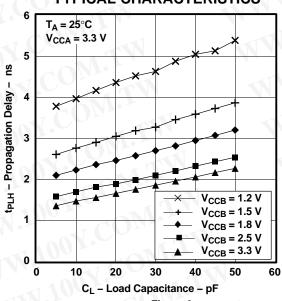
TYPICAL CHARACTERISTICS



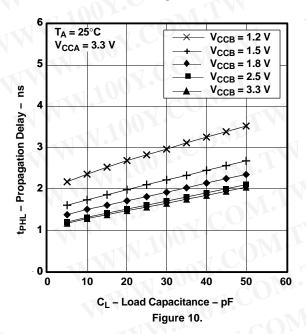
C_L – Load Capacitance – pF Figure 7.







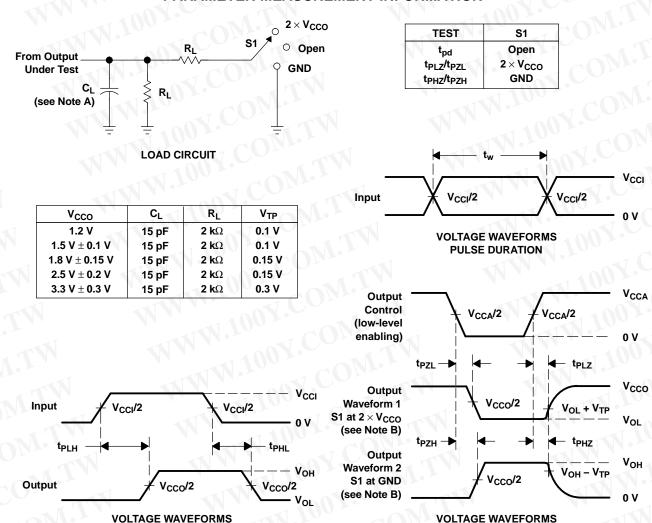




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PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $dv/dt \geq$ 1 V/ns.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
 - F. t_{PZL} and t_{PZH} are the same as t_{en}.
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. V_{CCI} is the V_{CC} associated with the input port.
 - I. V_{CCO} is the V_{CC} associated with the output port.

PROPAGATION DELAY TIMES

Figure 11. Load Circuit and Voltage Waveforms

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ENABLE AND DISABLE TIMES



PACKAGE OPTION ADDENDUM

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp (3)
74AVC16T245DGGRE4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74AVC16T245DGGRG4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74AVC16T245DGVRE4	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74AVC16T245DGVRG4	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
AVC16T245DGGR-D	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC16T245DGGR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC16T245DGVR	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC16T245GQLR	NRND	BGA MI CROSTA R JUNI OR	GQL	56	1000	TBD	SNPB	Level-1-240C-UNLIM
SN74AVC16T245ZQLR	ACTIVE	BGA MI CROSTA R JUNI OR	ZQL	56	1000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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PACKAGE OPTION ADDENDUM

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OTHER QUALIFIED VERSIONS OF SN74AVC16T245:

Automotive: SN74AVC16T245-Q1

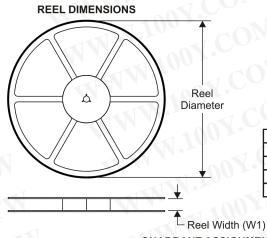
NOTE: Qualified Version Definitions:

• Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

PACKAGE MATERIALS INFORMATION

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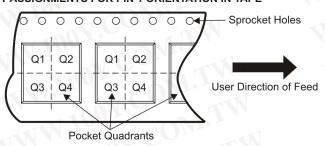
TAPE AND REEL INFORMATION



TAPE DIMENSIONS + K0 - P1 - B0 W Cavity - A0 -

	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

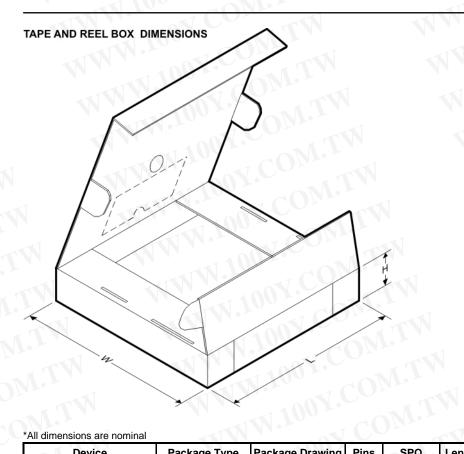


*All dimensions are nominal

U	*All dimensions are nominal			-73	70								
	Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	SN74AVC16T245DGGR	TSSOP	DGG	48	2000	330.0	24.4	8.6	15.8	1.8	12.0	24.0	Q1
	SN74AVC16T245DGVR	TVSOP	DGV	48	2000	330.0	16.4	7.1	10.2	1.6	12.0	16.0	Q1
	SN74AVC16T245GQLR	BGA MI CROSTA R JUNI OR	GQL	56	1000	330.0	16.4	4.8	7.3	1.45	8.0	16.0	Q1
	SN74AVC16T245GQLR	BGA MI CROSTA R JUNI OR	GQL	56	1000	330.0	16.4	4.8	7.3	1.5	8.0	16.0	Q1
	SN74AVC16T245ZQLR	BGA MI CROSTA R JUNI OR	ZQL	56	1000	330.0	16.4	4.8	7.3	1.5	8.0	16.0	Q1
	SN74AVC16T245ZQLR	BGA MI CROSTA R JUNI OR	ZQL	56	1000	330.0	16.4	4.8	7.3	1.45	8.0	16.0	Q1

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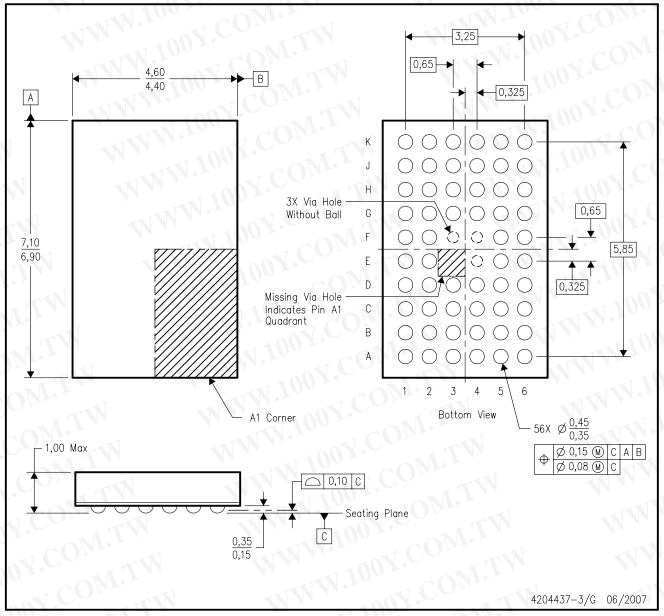
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All dimensions are nominal		-01	C) <u> </u>				
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
SN74AVC16T245DGGR	TSSOP	DGG	48	2000	346.0	346.0	41.0	
SN74AVC16T245DGVR	TVSOP	DGV	48	2000	346.0	346.0	33.0	
SN74AVC16T245GQLR	BGA MICROSTAR JUNIOR	GQL	56	1000	333.2	345.9	28.6	
SN74AVC16T245GQLR	BGA MICROSTAR JUNIOR	GQL	56	1000	333.2	345.9	28.6	
SN74AVC16T245ZQLR	BGA MICROSTAR JUNIOR	ZQL	56	1000	333.2	345.9	28.6	
SN74AVC16T245ZQLR	BGA MICROSTAR JUNIOR	ZQL	56	1000	333.2	345.9	28.6	

ZQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



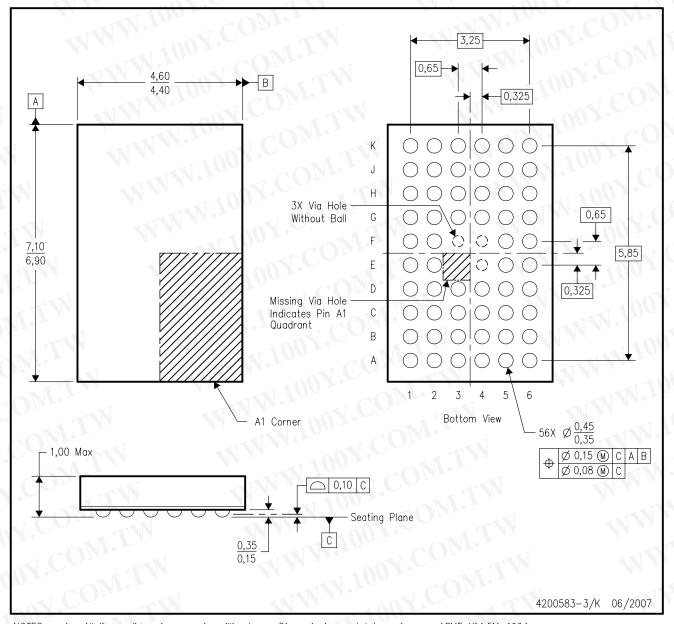
NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-285 variation BA-2.
- D. This package is lead-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).



GQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

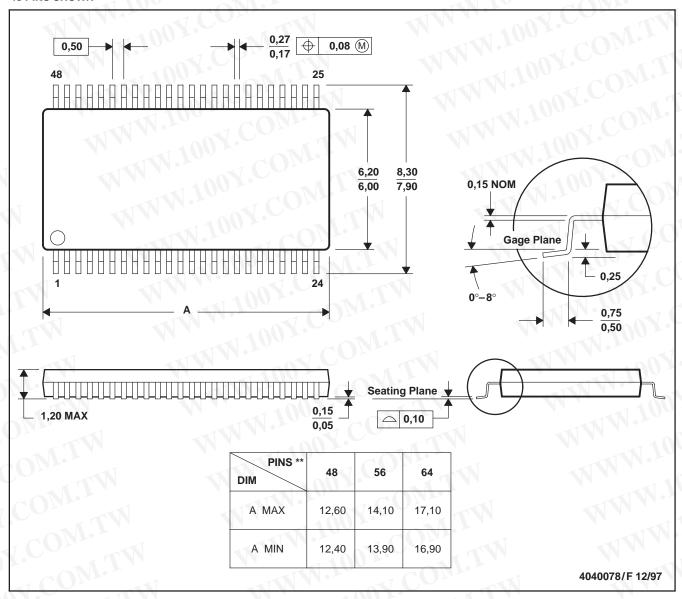
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-285 variation BA-2.
- D. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.



DGG (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153



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